

Pocan DPT7140LDS 000000

PET+PBT, 44% glass fibers/mineral, injection molding, LDS, high thermal dimension stability

ISO Shortname: ISO 20028-PET+PBT,(GF+MD)44,GHMR,07-120

Rheological properties	Property	Test Condition	Unit	Standard	guide value ¹
CMolding shrinkage, parallel 60x60x2: 280°C / WZ 10°C; 6800 bar ISO 294-4 0.2 CMolding shrinkage, transverse 60x60x2: 280°C / WZ 11°C; 6900 bar % ISO 294-4 0.7 Post- shrinkage, parallel 60x60x2: 120°C; 4 h % ISO 294-4 0.1 Post- shrinkage, transverse 60x60x2: 120°C; 4 h % ISO 294-4 0.2 Mechanical properties (23°C/50 % r. h.) Wechanical properties (23°C/50 % r. h.) CTensile Stress at break 5 mm/min MPa ISO 527-1,-2 12700 CTensile Stress at break 5 mm/min MPa ISO 527-1,-2 110 CTensile Stress at break 5 mm/min % ISO 527-1,-2 110 CTensile Stress at break 5 mm/min % ISO 527-1,-2 1.3 CCharpy impact strength 23°C kJ/m² ISO 179-1eU 30 CCharpy impact strength -30°C kJ/m² ISO 179-1eU 25 CCharpy notched impact strength -30°C kJ/m² ISO 180-1U 25 CCharpy notched impact strength -30°C kJ/m² ISO 180-1U 25 Izod impact strength -30°C	Rheological properties				
Molding shrinkage, transverse	C Melt volume-flow rate	280 °C; 2.16 kg	cm ³ /(10 min)	ISO 1133-1	21
110°C; 600 bar Post-shrinkage, parallel 60x60x2; 120°C; 4 h % ISO 294-4 0.1 Post-shrinkage, transverse 60x60x2; 120°C; 4 h % ISO 294-4 0.2	C Molding shrinkage, parallel		%	ISO 294-4	0.2
Post-shrinkage, transverse	C Molding shrinkage, transverse		%	ISO 294-4	0.7
Mechanical properties (23 °C/50 % r. h.) Imm/min MPa ISO 527-1,-2 12700 CTensile modulus 1 mm/min MPa ISO 527-1,-2 110 CTensile Stress at break 5 mm/min MPa ISO 527-1,-2 110 CTensile Strain at break 5 mm/min % ISO 527-1,-2 1.3 CCharpy impact strength 23 °C kJ/m² ISO 179-1eU 30 CCharpy pnotched impact strength 23 °C kJ/m² ISO 179-1eA <10	Post- shrinkage, parallel	60x60x2; 120 °C; 4 h	%	ISO 294-4	0.1
CTensile modulus 1 mm/min MPa ISO 527-1,-2 12700 CTensile Stress at break 5 mm/min MPa ISO 527-1,-2 110 CTensile Strein at break 5 mm/min % ISO 527-1,-2 1.3 CCharpy impact strength 23 °C kJ/m² ISO 179-1eU 30 CCharpy impact strength -30 °C kJ/m² ISO 179-1eU 25 CCharpy notched impact strength -30 °C kJ/m² ISO 179-1eA -10 CCharpy notched impact strength -30 °C kJ/m² ISO 180-1U 25 CCharpy notched impact strength -30 °C kJ/m² ISO 180-1U 25 Izod impact strength -30 °C kJ/m² ISO 180-1U 25 Izod impact strength -30 °C kJ/m² ISO 180-1U 25 Izod notched impact strength -30 °C kJ/m² ISO 180-1A <10	Post- shrinkage, transverse	60x60x2; 120 °C; 4 h	%	ISO 294-4	0.2
CTensile Stress at break 5 mm/min MPa ISO 527-1,-2 110 CTensile Strain at break 5 mm/min % ISO 527-1,-2 1.3 CCharpy impact strength 23 °C kJ/m² ISO 179-1eU 25 CCharpy impact strength 30 °C kJ/m² ISO 179-1eA <10	Mechanical properties (23 °C/50 % r. h.)				
CTensile Strain at break 5 mm/min % ISO 527-1,-2 1.3 CCharpy impact strength 23 °C kJ/m² ISO 179-1eU 30 CCharpy impact strength -30 °C kJ/m² ISO 179-1eU 25 CCharpy notched impact strength 23 °C kJ/m² ISO 179-1eA <10	C Tensile modulus	1 mm/min	MPa	ISO 527-1,-2	12700
C Charpy impact strength 23 °C kJ/m² ISO 179-1eU 30 C Charpy impact strength 30 °C kJ/m² ISO 179-1eU 25 C Charpy notched impact strength 23 °C kJ/m² ISO 179-1eA <10	C Tensile Stress at break	5 mm/min	MPa	ISO 527-1,-2	110
Charpy impact strength	C Tensile Strain at break	5 mm/min	%	ISO 527-1,-2	1.3
C Charpy notched impact strength 23 °C kJ/m² ISO 179-1eA <10 C Charpy notched impact strength -30 °C kJ/m² ISO 179-1eA <10	C Charpy impact strength	23 °C	kJ/m²	ISO 179-1eU	30
C Charpy notched impact strength -30 °C kJ/m² ISO 179-1eA <10 Izod impact strength 23 °C kJ/m² ISO 180-1U 25 Izod impact strength -30 °C kJ/m² ISO 180-1U 25 Izod notched impact strength 23 °C kJ/m² ISO 180-1A <10	C Charpy impact strength	-30 °C	kJ/m²	ISO 179-1eU	25
Izod impact strength	C Charpy notched impact strength	23 °C	kJ/m²	ISO 179-1eA	<10
Izod impact strength	C Charpy notched impact strength	-30 °C	kJ/m²	ISO 179-1eA	<10
Izod notched impact strength	Izod impact strength	23 °C	kJ/m²	ISO 180-1U	25
Izod notched impact strength	Izod impact strength	-30 °C	kJ/m²	ISO 180-1U	25
Flexural modulus	Izod notched impact strength	23 °C	kJ/m²	ISO 180-1A	<10
Flexural strength 2 mm/min MPa ISO 178-A 170 Flexural strain at flexural strength 2 mm/min % ISO 178-A 1.7 Thermal properties C Melting temperature 10 °C/min °C ISO 11357-1,-3 255 C Temperature of deflection under load 1.80 MPa °C ISO 75-1,-2 210 C Temperature of deflection under load 0.45 MPa °C ISO 75-1,-2 250 Vicat softening temperature 50 N; 120 °C/h °C ISO 306 225 C Coefficient of linear thermal expansion, parallel 23 to 55 °C 10 °I/K ISO 11359-1,-2 0.2 C Coefficient of linear thermal expansion, transverse 23 to 55 °C 10 °I/K ISO 11359-1,-2 0.5 C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) CRelative permittivity 1 MHz - IEC 60250 4.3 C Relative permittivity 1 MHz 10 °I IEC 60250	Izod notched impact strength	-30 °C	kJ/m²	ISO 180-1A	<10
Flexural strain at flexural strength	Flexural modulus	2 mm/min	MPa	ISO 178-A	12800
Thermal properties C Melting temperature 10 °C/min °C ISO 11357-1,-3 255 C Temperature of deflection under load 1.80 MPa °C ISO 75-1,-2 210 C Temperature of deflection under load 0.45 MPa °C ISO 75-1,-2 250 Vicat softening temperature 50 N; 120 °C/h °C ISO 306 225 C Coefficient of linear thermal expansion, parallel 23 to 55 °C 10°/K ISO 11359-1,-2 0.2 C Coefficient of linear thermal expansion, transverse 23 to 55 °C 10°/K ISO 11359-1,-2 0.5 C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) CRelative permittivity 100 Hz - IEC 60250 4.3 C Relative permittivity 1 MHz 10° IEC 60250 4.1 C Dissipation factor 1 MHz 10° IEC 60250 138 C Volume resistivity Ohm IEC 62631-3 2E18 C Sur	Flexural strength	2 mm/min	MPa	ISO 178-A	170
C Melting temperature 10 °C/min °C ISO 11357-1,-3 255 C Temperature of deflection under load 1.80 MPa °C ISO 75-1,-2 210 C Temperature of deflection under load 0.45 MPa °C ISO 75-1,-2 250 Vicat softening temperature 50 N; 120 °C/h °C ISO 306 225 C Coefficient of linear thermal expansion, parallel 23 to 55 °C 10 ⁴/K ISO 11359-1,-2 0.2 C Coefficient of linear thermal expansion, transverse 23 to 55 °C 10 ⁴/K ISO 11359-1,-2 0.5 C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) C Relative permittivity 1 00 Hz - IEC 60250 4.3 C Relative permittivity 1 MHz 10 ⁴ IEC 60250 22 C Dissipation factor 1 MHz 10 ⁴ IEC 60250 138 C Volume resistivity Ohm IEC 62631-3 5.4E16 C Surface resistivity	Flexural strain at flexural strength	2 mm/min	%	ISO 178-A	1.7
C Temperature of deflection under load 1.80 MPa °C ISO 75-1,-2 210 C Temperature of deflection under load 0.45 MPa °C ISO 75-1,-2 250 Vicat softening temperature 50 N; 120 °C/h °C ISO 306 225 C Coefficient of linear thermal expansion, parallel 23 to 55 °C 10 ⁴/K ISO 11359-1,-2 0.2 C Coefficient of linear thermal expansion, transverse 23 to 55 °C 10 ⁴/K ISO 11359-1,-2 0.5 C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) C Relative permittivity 100 Hz - IEC 60250 4.3 C Relative permittivity 1 MHz - IEC 60250 4.1 C Dissipation factor 100 Hz 10° IEC 60250 138 C Volume resistivity Ohm·m IEC 60250 138 C Surface resistivity Ohm IEC 60243-1 5.4E16 C Electric strength 1 mm	Thermal properties				
C Temperature of deflection under load 0.45 MPa °C ISO 75-1,-2 250 Vicat softening temperature 50 N; 120 °C/h °C ISO 306 225 C Coefficient of linear thermal expansion, parallel 23 to 55 °C 10 ⁴/K ISO 11359-1,-2 0.2 C Coefficient of linear thermal expansion, transverse 23 to 55 °C 10 ⁴/K ISO 11359-1,-2 0.5 C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) C V//MINION RESERTANCE V//MINION RESERTANCE V//MINION RESERTANCE V//MINION RESERTANCE C Relative permittivity 1 MHz - IEC 60250 4.3 C Relative permittivity 1 MHz 10⁴ IEC 60250 22 C Dissipation factor 1 MHz 10⁴ IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity <td>C Melting temperature</td> <td>10 °C/min</td> <td>°C</td> <td>ISO 11357-1,-3</td> <td>255</td>	C Melting temperature	10 °C/min	°C	ISO 11357-1,-3	255
Vicat softening temperature 50 N; 120 °C/h °C ISO 306 225 C Coefficient of linear thermal expansion, parallel 23 to 55 °C 10°4/K ISO 11359-1,-2 0.2 C Coefficient of linear thermal expansion, transverse 23 to 55 °C 10°4/K ISO 11359-1,-2 0.5 C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) Electrical properties (23 °C/50 % r. h.) - IEC 60250 4.3 C Relative permittivity 1 MHz - IEC 60250 4.1 C Dissipation factor 100 Hz 10° 4 IEC 60250 22 C Dissipation factor 1 MHz 10° 4 IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 60243-1 33	C Temperature of deflection under load	1.80 MPa	°C	ISO 75-1,-2	210
C Coefficient of linear thermal expansion, parallel 23 to 55 °C 10 ⁴ /K ISO 11359-1,-2 0.2 C Coefficient of linear thermal expansion, transverse 23 to 55 °C 10 ⁴ /K ISO 11359-1,-2 0.5 C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) C Relative permittivity 100 Hz - IEC 60250 4.3 C Relative permittivity 1 MHz - IEC 60250 4.1 C Dissipation factor 100 Hz 10 ⁴ IEC 60250 22 C Dissipation factor 1 MHz 10 ⁴ IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	C Temperature of deflection under load	0.45 MPa	°C	ISO 75-1,-2	250
C Coefficient of linear thermal expansion, transverse 23 to 55 °C 10 ⁴/K ISO 11359-1,-2 0.5 C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) C Relative permittivity 100 Hz - IEC 60250 4.3 C Relative permittivity 1 MHz - IEC 60250 4.1 C Dissipation factor 100 Hz 10 ⁴ IEC 60250 22 C Dissipation factor 1 MHz 10 ⁴ IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	Vicat softening temperature	50 N; 120 °C/h	°C	ISO 306	225
C Burning behavior UL 94 Class UL 94 HB Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.) C Relative permittivity 100 Hz - IEC 60250 4.3 C Relative permittivity 1 MHz - IEC 60250 4.1 C Dissipation factor 100 Hz 10°4 IEC 60250 22 C Dissipation factor 1 MHz 10°4 IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	C Coefficient of linear thermal expansion, parallel	23 to 55 °C	10 ⁻⁴ /K	ISO 11359-1,-2	0.2
Thermal conductivity 23 °C W/(m·K) ISO 8302 0.3 Electrical properties (23 °C/50 % r. h.)	C Coefficient of linear thermal expansion, transverse	23 to 55 °C	10 ⁻⁴ /K	ISO 11359-1,-2	0.5
Electrical properties (23 °C/50 % r. h.) C Relative permittivity 100 Hz - IEC 60250 4.3 C Relative permittivity 1 MHz - IEC 60250 4.1 C Dissipation factor 100 Hz 10°4 IEC 60250 22 C Dissipation factor 1 MHz 10°4 IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	C Burning behavior UL 94	'	Class	UL 94	НВ
C Relative permittivity 100 Hz - IEC 60250 4.3 C Relative permittivity 1 MHz - IEC 60250 4.1 C Dissipation factor 100 Hz 10°4 IEC 60250 22 C Dissipation factor 1 MHz 10°4 IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	Thermal conductivity	23 °C	W/(m·K)	ISO 8302	0.3
C Relative permittivity 1 MHz - IEC 60250 4.1 C Dissipation factor 100 Hz 10 ⁻⁴ IEC 60250 22 C Dissipation factor 1 MHz 10 ⁻⁴ IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	Electrical properties (23 °C/50 % r. h.)	,	'		
C Dissipation factor 100 Hz 10 ⁻⁴ IEC 60250 22 C Dissipation factor 1 MHz 10 ⁻⁴ IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	C Relative permittivity	100 Hz	-	IEC 60250	4.3
C Dissipation factor 1 MHz 10 ⁻⁴ IEC 60250 138 C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	C Relative permittivity	1 MHz	-	IEC 60250	4.1
C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	C Dissipation factor	100 Hz	10 ⁻⁴	IEC 60250	22
C Volume resistivity Ohm·m IEC 62631-3 2E18 C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	C Dissipation factor	1 MHz	10-4	IEC 60250	138
C Surface resistivity Ohm IEC 62631-3 5.4E16 C Electric strength 1 mm kV/mm IEC 60243-1 33	C Volume resistivity			IEC 62631-3	2E18
C Electric strength 1 mm kV/mm IEC 60243-1 33	-				
		1 mm	kV/mm		
	C Comparative tracking index CTI	Solution A	Rating	IEC 60112	275







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Property	Test Condition	Unit	Standard	guide value ¹
Other properties (23 °C)				
C Density		kg/m³	ISO 1183	1740
Bulk density		kg/m³	ISO 60	1000
Material specific properties				
C Viscosity number		cm³/g	ISO 1628-5	50
Processing conditions for test specimens				
C Injection molding-Melt temperature		°C	ISO 294	280
C Injection molding-Mold temperature		°C	ISO 294	110
Processing recommendations				
Drying temperature circulating air dryer		°C	=	120
Drying time circulating air dryer		h	-	4-8
Residual moisture content		%	Acc. to Karl Fischer	0.00-0.02
Melt temperature (Tmin - Tmax)		°C	-	270-290
Mold temperature	,	°C	-	100-130

Notes



¹ Typical properties: these are not to be construed as specifications

C These property characteristics are taken from the CAMPUS plastics data bank and are based on the international catalogue of basic data for plastics according to ISO 10350.

DATA SHEET



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Disclaimer

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This information and our technical advice - whether verbal, in writing or by way of trials - are given in good faith but without warranty, and this also applies where proprietary rights of third parties are involved. Our advice does not release you from the obligation to verify the information currently provided - especially that contained in our safety data and technical information sheets - and to test our products as to their suitability for the intended processes and uses. The application, use and processing of our products and the products manufactured by you on the basis of our technical advice are beyond our control and, therefore, entirely your own responsibility. Our products are sold in accordance with the current version of our General Conditions of Sale and Delivery.

Unless specified to the contrary, the values given have been established on standardized test specimens at room temperature. The figures should be regarded as guide values only and not as binding minimum values. Kindly note that, under certain conditions, the properties can be affected to a considerable extent by the design of the mould/die, the processing conditions and the coloring.

Processing note

Under the recommended processing conditions small quantities of decomposition product may be given off during processing. To preclude any risk to the health and well-being of the machine operatives, tolerance limits for the work environment must be ensured by the provision of efficient exhaust ventilation and fresh air at the workplace in accordance with the Safety Data Sheet. In order to prevent the partial decomposition of the polymer and the generation of volatile decomposition products, the prescribed processing temperatures should not be substantially exceeded. Since excessively high temperatures are generally the result of operator error or defects in the heating system, special care and controls are essential in these areas.

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